



CERAMIC

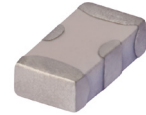
High Pass Filter

HFCN-880D+

50Ω 950 to 3200 MHz

THE BIG DEAL

- Low Cost
- Small Size
- 7 Sections
- Temperature Stable
- LTCC Construction
- Excellent Power Handling, 7 W
- Hermetically Sealed



Generic photo used for illustration purposes only

CASE STYLE: FV1206

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Sub-Harmonic Rejection
- Transmitters/Receivers
- Lab Use

ELECTRICAL SPECIFICATIONS^{1,2} AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Stopband	Rejection Loss	500	40		dB
		640	20		
	Freq. Cut-Off	880	3.0		dB
	VSWR	500-640	20		:1
Passband	Insertion Loss	950-3200	2.0		dB
		1060-2500		1.3	dB
	VSWR	970-2400	1.5		:1

1. DC Resistance to ground is 100 Mohms min.

2. Measured on Mini-Circuits Characterization Test Board TB-HFCN-880D+.

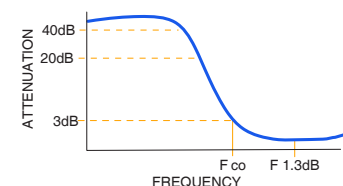
ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input ³	7 W max. at +25°C
Max. DC Voltage at Pins 1 & 3	+25 VDC

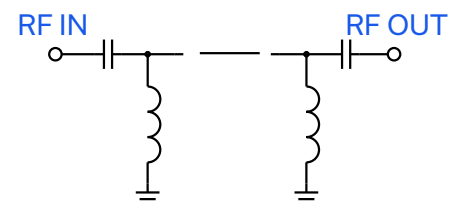
3. Passband rating, derate linearly to 3 W at +100°C ambient.

Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC





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CERAMIC

High Pass Filter

HFCN-880D+

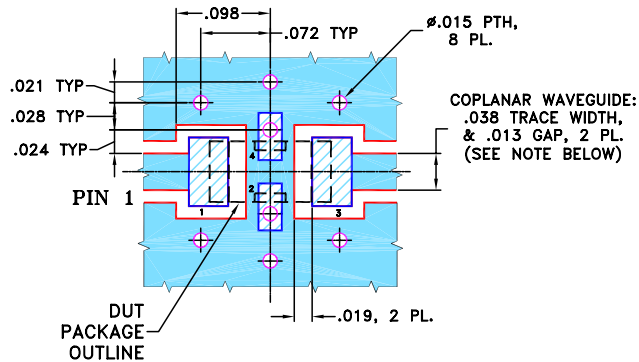
50Ω 950 to 3200 MHz

PIN CONNECTIONS

RF IN	1
RF OUT	3
GROUND	2,4

PRODUCT MARKING: F2

DEMO BOARD MCL P/N: TB-HFCN-880D+
SUGGESTED PCB LAYOUT (PL-137)

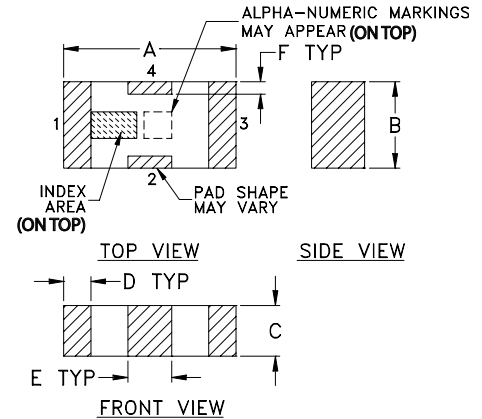


NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH THICKNESS .020" ± .0015".
COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

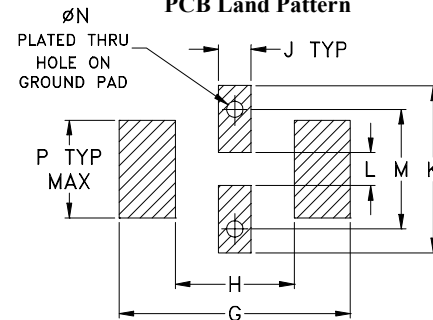
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

-  DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
-  DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches
mm)

A	B	C	D	E	F	G	H	J	K	L	M	N	P	wt
.126	.063	.037	.020	.032	.009	.169	.087	.024	.122	.024	.087	.012	.071	grams
3.20	1.60	0.94	0.51	0.81	0.23	4.29	2.21	0.61	3.10	0.61	2.21	0.30	1.80	.020

TAPE & REEL INFORMATION: F71



CERAMIC

High Pass Filter

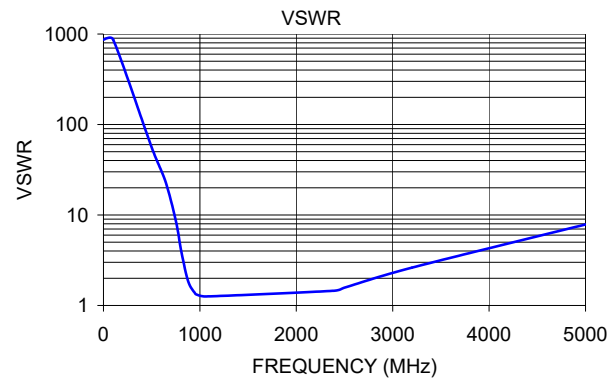
HFCN-880D+

Mini-Circuits

50Ω 950 to 3200 MHz

TYPICAL PERFORMANCE DATA AT +25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR :1
1	82.28	868.59
100	78.78	868.59
500	45.84	56.04
640	23.68	24.14
750	10.22	8.68
810	4.85	3.84
880	1.97	1.83
950	1.17	1.36
970	1.06	1.32
1060	0.83	1.26
2400	0.52	1.46
2500	0.60	1.58
3200	1.42	2.62
5000	5.12	7.87



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Ceramic High Pass Filter

HFCN-880D+

Typical Performance Data

FREQ. (MHz)	INSERTION LOSS (dB)			INPUT RETURN LOSS (dB)			OUTPUT RETURNLOSS (dB)		
	@ -55° C	@ +25° C	@ +100° C	@ -55° C	@ +25° C	@ +100° C	@ -55° C	@ +25° C	@ +100° C
1	73.96	82.28	74.30	0.01	0.02	0.01	0.02	0.02	0.00
50	63.45	71.77	63.78	0.01	0.02	0.01	0.01	0.01	0.00
100	63.19	61.97	59.77	0.00	0.00	0.02	0.01	0.04	0.01
200	57.40	56.85	57.15	0.05	0.08	0.09	0.01	0.05	0.04
395	58.01	58.72	59.33	0.14	0.20	0.22	0.13	0.18	0.20
425	64.34	66.61	66.03	0.16	0.23	0.27	0.15	0.22	0.24
460	58.17	56.27	55.13	0.19	0.27	0.30	0.16	0.23	0.28
500	46.62	45.84	45.02	0.22	0.31	0.39	0.20	0.28	0.33
520	42.63	41.83	41.36	0.29	0.37	0.44	0.24	0.36	0.41
590	31.19	30.63	30.16	0.41	0.55	0.62	0.41	0.51	0.60
640	24.19	23.68	23.24	0.54	0.72	0.81	0.51	0.67	0.77
665	20.92	20.44	19.97	0.68	0.88	1.00	0.65	0.79	0.91
750	10.59	10.22	9.82	1.65	2.01	2.37	1.51	1.84	2.14
805	5.39	5.21	5.00	3.66	4.29	5.02	3.43	4.00	4.64
840	3.23	3.20	3.14	6.01	6.88	7.81	5.70	6.47	7.30
880	1.91	1.97	2.05	9.60	10.64	11.63	9.16	10.09	10.96
900	1.51	1.62	1.73	11.42	12.50	13.41	11.01	11.97	12.80
950	1.04	1.17	1.33	15.27	16.29	16.70	15.11	16.07	16.60
960	0.97	1.12	1.25	15.84	16.83	17.12	15.73	16.67	17.13
970	0.94	1.06	1.21	16.38	17.31	17.49	16.27	17.17	17.56
990	0.84	0.98	1.13	17.20	17.99	18.02	17.28	18.12	18.31
1000	0.82	0.97	1.10	17.45	18.20	18.14	17.69	18.51	18.60
1060	0.70	0.83	0.96	18.39	18.82	18.46	18.62	19.17	18.89
1235	0.54	0.66	0.77	17.61	17.47	17.36	17.75	17.57	17.54
1500	0.41	0.49	0.58	18.70	18.84	19.45	18.73	18.93	19.70
1650	0.35	0.44	0.53	22.31	22.25	23.05	22.54	22.64	23.71
2000	0.28	0.36	0.48	26.70	25.94	25.11	27.42	27.11	26.89
2200	0.29	0.40	0.52	19.03	18.52	18.19	19.06	18.64	18.56
2400	0.40	0.52	0.63	14.94	14.63	14.35	14.89	14.64	14.52
2450	0.42	0.55	0.67	14.09	13.81	13.51	14.06	13.83	13.67
2500	0.47	0.60	0.70	13.25	13.02	12.74	13.19	12.99	12.81
2800	0.72	0.86	1.01	9.94	9.82	9.60	9.88	9.77	9.61
3200	1.29	1.42	1.56	6.96	6.98	7.01	7.00	6.97	6.93
4000	2.62	2.85	3.02	3.88	3.95	4.07	3.92	3.95	3.99
4740	4.21	4.54	4.82	2.56	2.60	2.67	2.49	2.55	2.60
5500	6.15	6.39	6.79	1.65	1.90	2.05	1.58	1.79	1.94
6000	7.99	8.11	8.39	1.23	1.51	1.68	1.20	1.41	1.57
6500	9.74	10.05	10.62	1.09	1.26	1.38	1.05	1.22	1.36
7030	16.82	20.06	19.23	0.95	1.34	1.79	0.96	1.49	2.27
7290	5.91	5.71	6.41	6.02	5.11	3.74	9.25	7.13	4.89
8000	9.17	9.77	10.57	1.17	1.28	1.25	1.09	1.23	1.35

REV. X1

HFCN-880D+

070930

Page 1 of 1



IF/RF MICROWAVE COMPONENTS • ISO 9001 ISO 14001 AS9100 CERTIFIED RoHS compliant

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

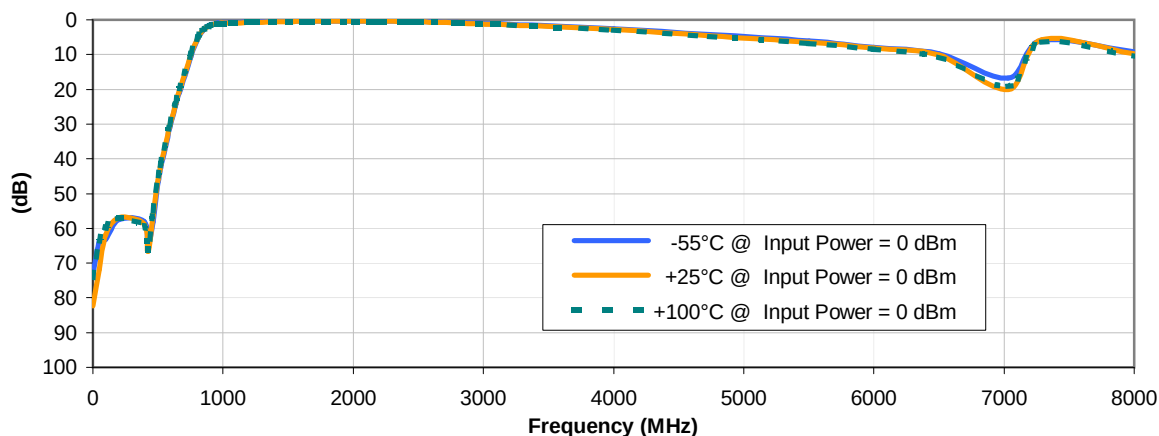


The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see

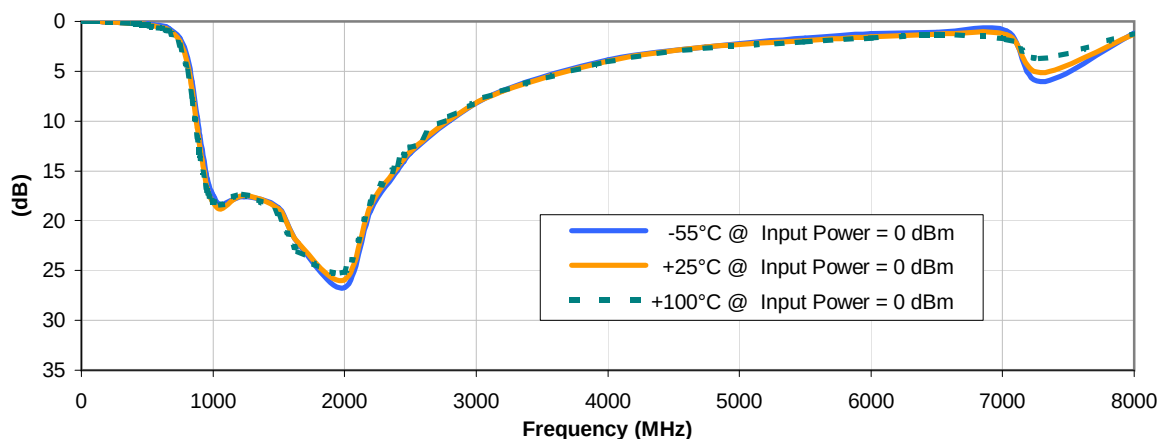


Typical Performance Curves

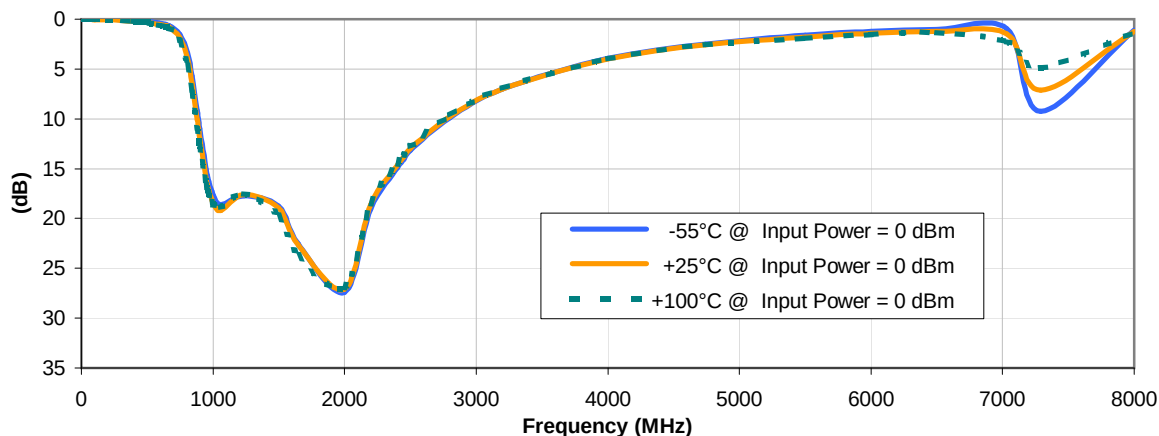
INSERTION LOSS vs. TEMPERATURE



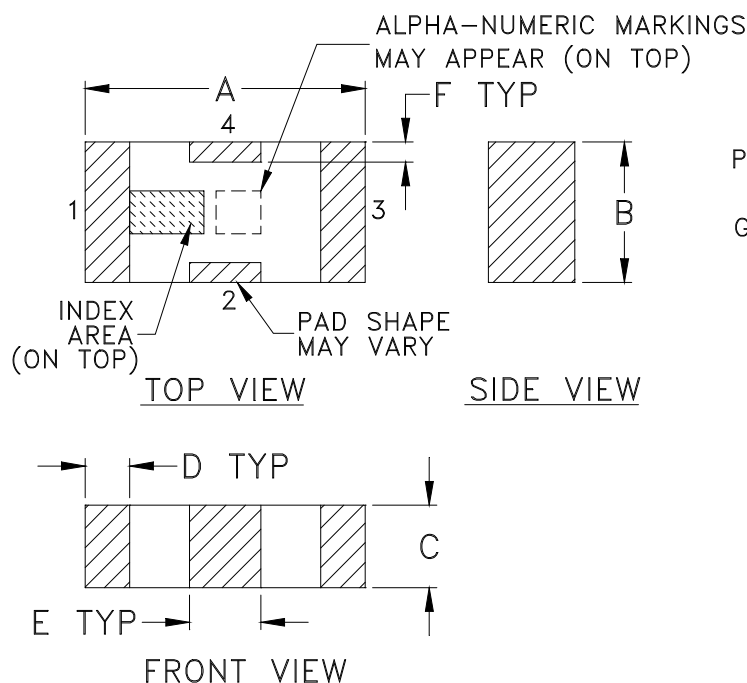
INPUT RETURN LOSS vs. TEMPERATURE



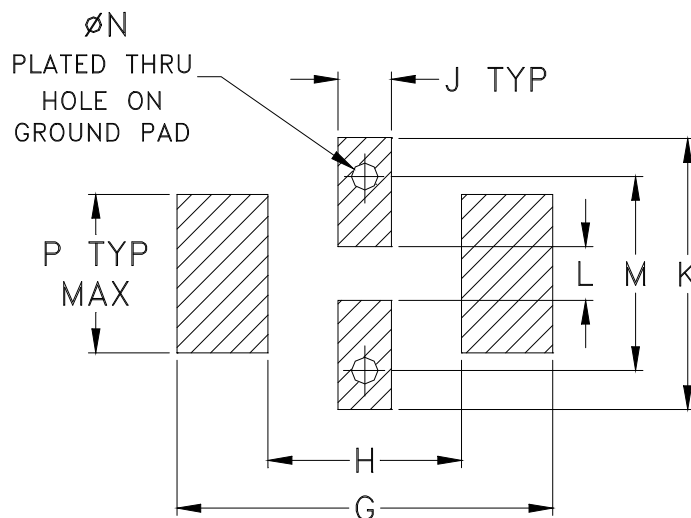
OUTPUT RETURN LOSS vs. TEMPERATURE



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F71

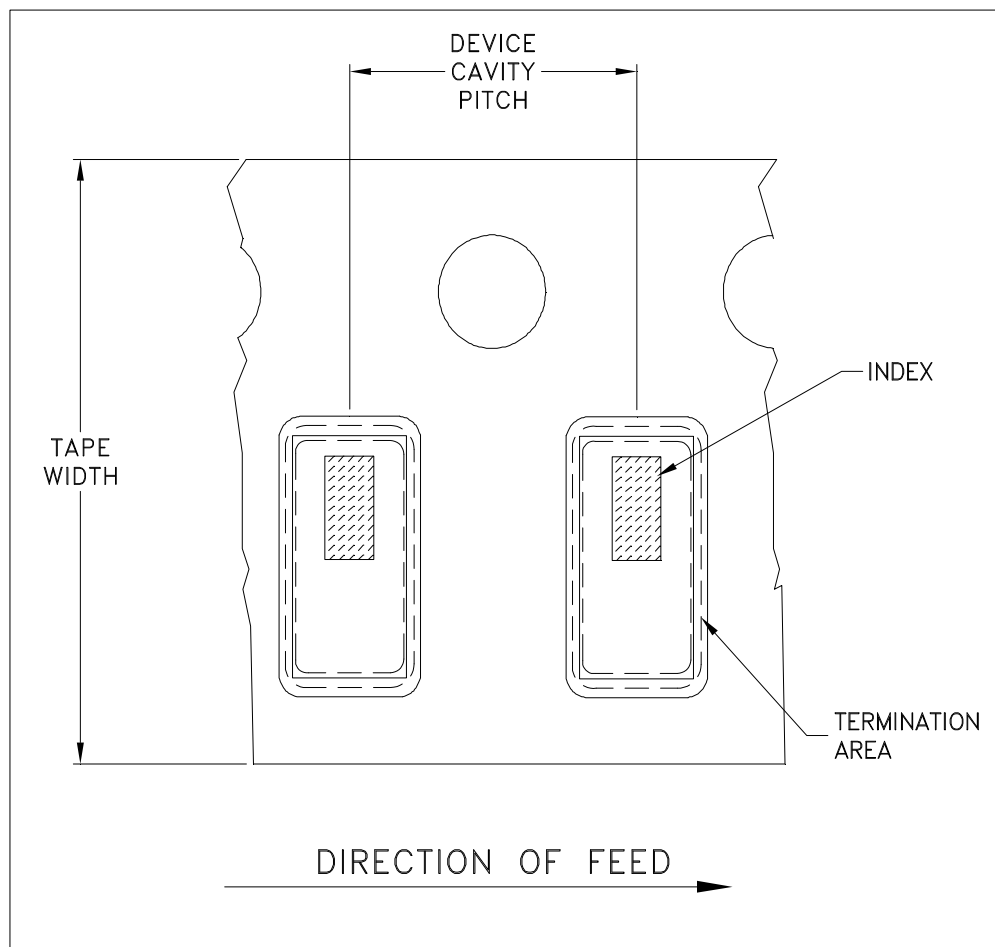


ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



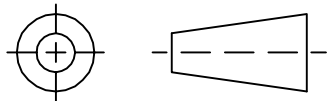
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RF/IF MICROWAVE COMPONENTS

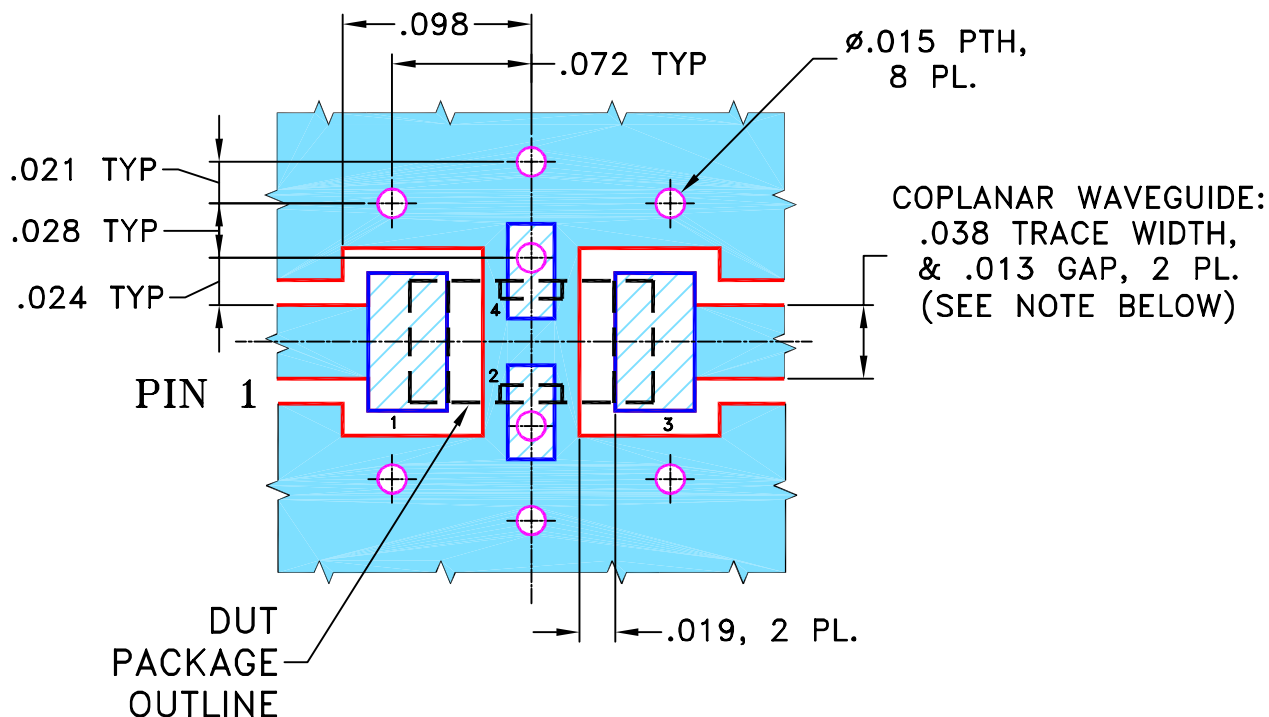
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206 CASE STYLE, "nx" PIN CONNECTION

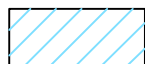


NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH THICKNESS .020" $\pm$.0015".
 COPPER: 1/2 OZ. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
 (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

GF

08/27/03

CHECKED

AV

08/28/03

APPROVED

ABD

08/28/03



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, nx, FV1206, LFCN/HFCN, TB-270

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-137

REV:

A

FILE:

98PL137

SCALE:

10:1

SHEET:

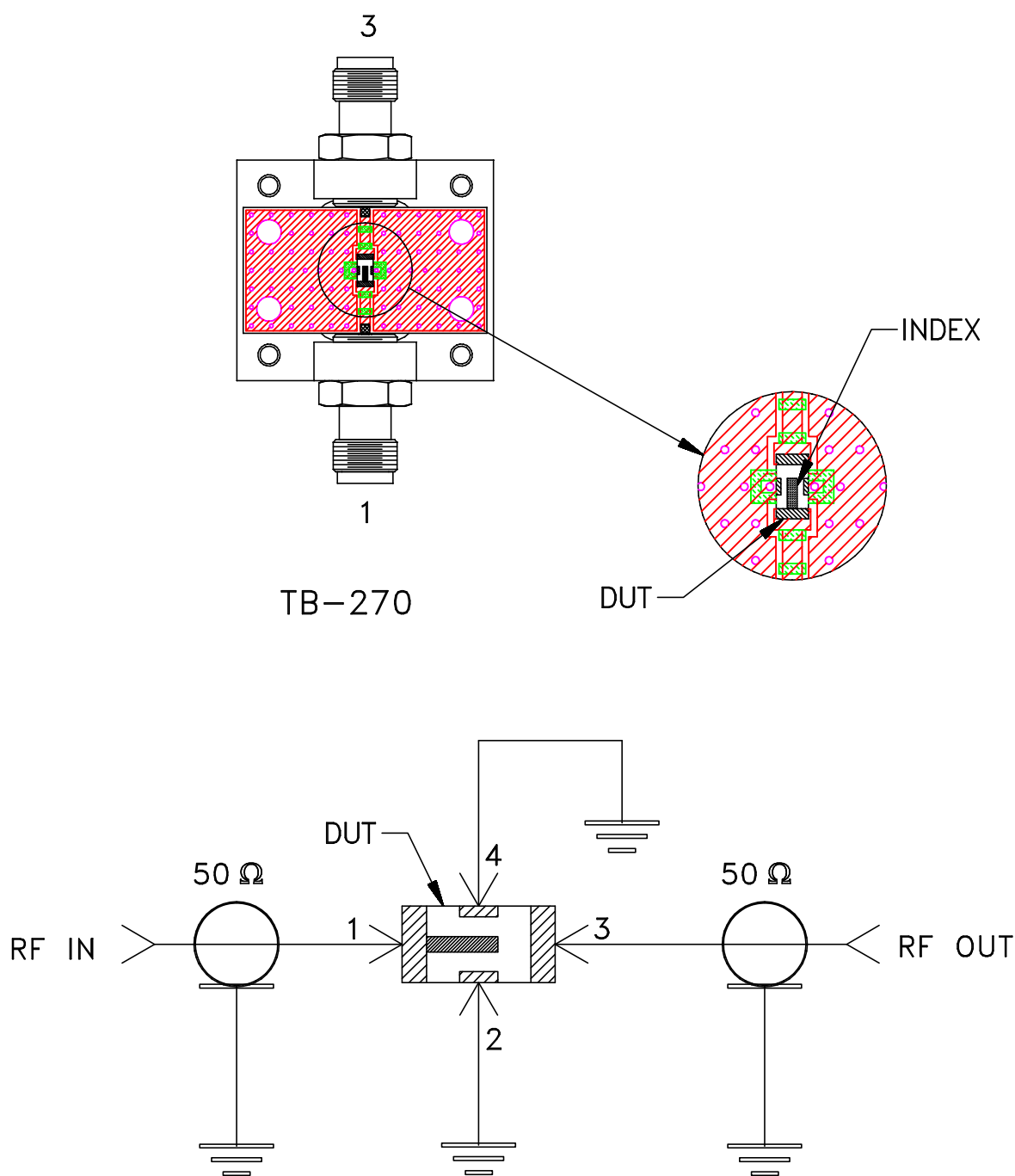
1 OF 1

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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS RO4350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A